Original and Supplementary Data for Paper:

"Bipolar device fabrication using a scanning tunneling microscope"

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Fig.1 - Original and supplementary STM images

STM Image processing:

- STM images were accquired with the Omicron Scala software using a unix control computer. Later (images in Figs. 4 and 5) we used a custom built in-house control software and hardware to accquire STM scans.
- The Gwyddion software package and pyplot was used to plot STM images
- Most Images were processed by subtracting a linear background
- In a few cases a line-by-line average subtraction was made
- For the figures in the paper the images were cropped, in some cases corrected for drift and scaled using the period of the dimer rows of the silicon (100) surface.



Fig. 1f and g







Fig. 1f and g

zoom of upper region for Fig. 1g







Fig. 1f and g – additional data (not shown in paper)







Additional data (not shown in paper): 9L diborane dose and different in-situ anneals



SIMS data for:

- phosphorus δ -layer
- boron δ -layer
- boron with locking δ -layer



0

10

10²²

10²¹

10²⁰

10¹⁹

10¹⁸

10¹⁷

 10^{16}

-10

Concetration [at./cm²]

тсст

-2

0

Concetration [at./cm³]

1.5

1.0

0.5

0.0

-4

S1 - ¹¹B

S1 - ¹⁰B

S2 - ¹¹B

S2 - ¹⁰B

4

6

. . . .

. . . .

2

Comments & Info.csv

Data_BinSi Ref.csv

Data_PinSi_Ref.csv

Data_S1_InROI.csv

Depths.csv

Data_S1_NextToROI.csv Data_S2_InROI.csv

Data_S2_NextToROI.csv

Data_S3_NextToROI.csv

Data_S3_P-template_InROI.csv

Data_S3_P-template_NextToROI.csv

Fig.3 - Transport Data on boron δ -layers

Hall bar samples:

- typical sample size is 2.7 mm x 9 mm of which only a length of 5 6 mm contains the δ -layer
- the Hall bars are patterned using e-beam lithography and then cut into three chips which were annealed at different temperatures (sometimes sequentially after measurement)
- chips are glued into ceramic chip carriers with silver epoxy (epotec) and bonded using Al bond wire
- Rxx and Rxy was measured in two different cryostats (PPMS, Oxford Spectromag) for many Hall bars and standard Hall analysis was used to determine mobilities and densities



Fig. 3 - List of Samples

Sample										
name	Symbol	part	type	Dose	Anneal T+time	Anneal type	Hallbar	Cryostat	Comments	Si overgrowth
				STM		In-situ anneal				standard, starting sample
	Notes			manipulator with	contact anneal not mentioned for any	in general				with resistive and start
		10100		resistive and	annealing procedure, in-situ Pyrometer if not	with 1.5-2nm				direct keeping it below
				ZUP	otherwise stated	Si cap				300C in Pyrometer
nSi#40		all	B delta	2.7L (slow	350C Pyro 1min	In-situ	yes, Pt		first try of B delta	pyro below 300C
A				open) 22%;	250C 2min contact anneal	Ex-situ				
	^	middle, bonded		100-130C				Oxford	no measure between	
В	ম	1A			410C 2min	Ex-situ				
С		2A			650C 2min	Ex-situ				
D		1B			850C 2min	Ex-situ				
		2B								
nSi#48			B delta	338L heating		Ex-situ	yes, Pt			
	•	1A		forgot to note,	250C 2min / 800C 10s			Oxford	sample cut and	
	Δ	1B, bonded		probably 30%	250C 2min / 800C 1.5s			Oxford	annealed after hallbar	18nm, standard
В		middle, bonded			250C 2min / 600C 2min / 800C 4s / 850C			Oxford		
A		2A/B, bonded			250C 2min / 800C 2min			Oxford		
nSi#54		all	B delta	570L		Ex-situ	yes, Pt		sample cut and	18nm, standard,
	_	1A			250C 2min / 700C 2min / 850C 2min			ppms	annealed after hallbar	temperature the lowest as
A, C		1B , bonded			250C 2min / 700C 2min / 900C 2min			ppms		possible with direct. for
B, D, F		middle			600C 2min / 750C 2min / 850C 80s			Ppms / Oxford	new contacts after	for Grenoble as a backup
E		2A / 2B			800C 2min			Ppms / Oxford	sample lost	
nSi#83		all	B delta	900L, 30%	13s 850C Pyro	In-situ	yes Pt			15nm, start standard, after
A		middle, bonded						Oxford	temp possibly a bit	2nm turn out sample, 850C
		1A							lower mainly watched	5sec (might have been
		1B (dirt)							current	even shorter difficult with
		2A							current	power supply), continue
		2B								growth 5min 350C,then
nSi#88		all	B delta	570L, 30%	10s, 830C 2.5A, last 2-3s corrected to 850C	In-situ	yes, Pt		2nm interlayer	
A	+	middle, bonded						Oxford	standard, then	15nm standard
		1A,1B, 2A,2B							incorporation anneal	
nSi#129		all	B delta	90L,25% 95c-	1.5min 350C, 0.5min 405C	In situ	yes, Pt			
		all		176C	contact anneal 250C 1.5min	Ex-situ			no interlayer before in-	
		middle		4	1080C 2min				situ anneal ex-situ in	18nm standard
	\triangle	1A			850C 2min, 931C 2min	Ex-situ			RTA clean room	
A		1B		1	410C 2min,?C 2min	Ex-situ				
В		2A			650C 2min	Ex-situ				
		2B			1000C 2min	Ex-situ			dirty	

Fig. 3a Temp-sweeps overview (PPMS)

nSi#54 590L dose

in-situ 250C 2min



in-situ 250C 2min

Fig. 3a Temp-sweeps overview (Oxford)

nSi#48 338L dose



in-situ 250C 2min

Fig. 3c-d Magnetoresistance Data nSi#54

nSi#54 590L dose

- Measured on PPMS system
- 900C sample had contact problems after anneal





mobility and density as a function of annealing temperature extracted from the following Hall measurements

Fig. 3c-d Magnetoresistance Data nSi#54

nSi#54 590L dose



in-situ 250C 2min

Fig. 3c-d B sweeps 250C sample (PPMS)



in-situ 250C 2min

Fig. 3c-d B sweeps 600 C sample (PPMS)

	T(K)	Ns(nm⁻²)	Mu(cm²/Vs)	Rho0(Ohm)	Sig0 (mS)
blue	10	1.12	20.06	2786.1	0.359
green	15	1.14	19.72	2769.85	0.361
red	20	1.16	19.51	2760.54	0.362
cyan	25	1.17	19.35	2754.51	0.363
magenta	30	1.18	19.27	2747.69	0.364
yellow	35	1.18	19.46	2708.75	0.369



Fig. 3c-d B sweeps 700 C sample (PPMS)

	T(K)	Ns(nm⁻²)	Mu(cm²/Vs)	Rho0(Ohm)	Sig0(mS)
blue	10	1.23	40.46	1258.1	0.795
green	15	1.24	39.96	1260.34	0.793
red	20	1.25	39.57	1263.65	0.791
cyan	25	1.26	39.21	1267.46	0.789
magenta	30	1.26	38.92	1270.95	0.787
yellow	35	1.27	38.89	1268.58	0.788



in-situ 250C 2min

Fig. 3c-d B sweeps 750 C sample (PPMS)





in-situ 250C 2min Fig. 3c-d B sweeps 800C sample (Oxford)

	T(K)	Ns(nm ⁻²)	Mu(cm²/Vs)	Rho0(Ohm)	Sig0 (mS)
blue	4	2.15	56.34	516.05	1.938
green	6	2.18	54.81	521.95	1.916
red	8.7	2.27	52.67	522.05	1.916
cyan	10.8	2.4	49.75	522.27	1.915
magenta	4	2.22	54.1	520.88	1.92
yellow	6	2.21	54.21	521.97	1.916





Fig. 3c-d B sweeps 850C sample (Oxford)

Measurement Temperature dependence

T(K)	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
4.6	2.17	93.65	307.72	3.25
6.8	3.21	62.41	311.17	3.214
8.8	3.4	58.92	311.71	3.208
10.9	3.38	59.15	311.96	3.206
16.1	3.62	55.21	312.74	3.198
21.2	3.57	55.76	313.56	3.189
25.9	3.52	56.46	314.46	3.18
4.6	-2.35	86.24	307.87	3.248
6.7	3.43	58.51	311.16	3.214
8.8	3.2	62.51	311.77	3.207
10.9	3.57	56.04	312.02	3.205
15.7	3.26	61.29	312.65	3.198
20.3	3.25	61.23	313.45	3.19
24.7	3.4	58.49	314.28	3.182

4.6 K - blue 6.8 K - green 8.8 K - red 10.9 K - cyan 16.1 K – magenta 21.2 K - yellow 25.9 K - black



Fig. 3c-d Sample nSi#48

T_{anneal :}

red = 2min

blue= 4sec green=10sec

Annealing time dependence at 800C:

- At least for 10s still seems metallic down to 10K
- Densities for 4s better than for others! But close to 120s, 10s about 2x smaller
- For 4sec at low T resistance rising again? (others not measured for such small T)



Fig. 3c-d B sweeps 800C 120s (PPMS)

Temperature dependence

	T(K)	Ns(nm⁻²)	Mu(cm²/Vs)	Rho0(Ohm)	Sig0 (mS)
blue	10	-1.86	52.76	635.17	1.574
green	15	-1.87	52.51	635.86	1.573
red	20	-1.87	52.24	638.25	1.567
cyan	25	-1.87	51.99	641.45	1.559
magenta	30	-1.87	51.82	644.02	1.553
yellow	35	-1.87	51.81	645.93	1.548





in-situ 250C 2min Fig. 3c-d B sweeps 800C 4s (Oxford)

Temperature dependence

	T(K)	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0 (mS)
blue	2.6	2.07	52.25	576.96	1.733
green	4.6	2.09	51.89	576.48	1.735
red	6.6	2.1	51.65	576.49	1.735
cyan	8.7	2.1	51.5	576.46	1.735
magenta	10.8	2.11	51.34	576.88	1.733
yellow	16.1	2.11	51.04	578.28	1.729
black	21	2.12	50.83	580.02	1.724
blue	25.7	2.12	50.63	582.29	1.717
green	2.7	2.07	52.22	576.99	1.733
red	4.6	2.09	51.86	576.48	1.735
cyan	6.6	2.1	51.69	575.98	1.736
magenta	8.6	2.1	51.5	576.45	1.735
yellow	10.7	2.11	51.34	576.76	1.734
black	15.7	2.11	51.05	578.26	1.729
blue	20.2	2.12	50.85	579.89	1.724
green	24.6	2.12	50.63	582.31	1.717



Fig. 3c-d B sweeps 800C 10s (PPMS)

Temperature dependence

	T(K)	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
blue	10	1.15	48.34	1124.53	0.889
green	15	1.16	47.91	1127.62	0.887
red	20	1.16	47.58	1131.47	0.884
cyan	25	1.16	47.27	1135.82	0.88
magenta	30	1.16	47.11	1140.43	0.877
yellow	35	1.16	47.15	1143.61	0.874





in-situ 350C 1min

Fig. 3c-d Nsi#40 410C 2min

	T(K)	[Tdiff]	Ns(nm-2)	Mu(cm2/Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.5	0.1	1.08	20.24	2855.5	0.35
blue	2.5	0.1	1.08	20.24	2856.14	0.35
green	4.5	0.26	1.13	19.7	2813.95	0.355
green	4.6	0.25	1.13	19.69	2812.57	0.356
red	9.3	0.68	1.18	19.15	2771.82	0.361
red	8.9	0.6	1.17	19.18	2773.65	0.361
cyan	11.8	0.92	1.19	18.98	2759.36	0.362
cyan	11.2	0.79	1.19	19.02	2762.26	0.362



in-situ 350C 1min

Fig. 3c-d Nsi#40 850C 2min

	T(K)	T _{diff}	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.4	0.2	1.3	57.95	829.07	1.206
blue	2.4	0.2	1.31	57.6	829.08	1.206
green	4.6	0.23	1.32	57.07	827.49	1.208
green	4.6	0.22	1.32	57.01	827.48	1.208
red	9	0.57	1.34	56.49	827.53	1.208
red	8.9	0.42	1.34	56.41	827.48	1.208
cyan	11.5	0.88	1.34	56.37	828.11	1.208
cyan	11	0.41	1.34	56.21	828.02	1.208



Fig. 3c-d Nsi#129 410C 2min ex-situ

	T(K)	[Tdiff]	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.4	0.1	0.9	15.08	4602.88	0.217
blue	2.4	0.13	0.9	15.09	4599.48	0.217
green	4.5	0.12	0.97	14.3	4522.29	0.221
green	4.6	0.2	0.96	14.32	4520.52	0.221
red	8.8	0.25	1.03	13.68	4442.44	0.225
red	8.8	0.32	1.03	13.7	4442.55	0.225
cyan	11.3	0.4	1.05	13.47	4415.12	0.226



in-situ 350C 1min

Fig. 3c-d Nsi#40 650C 2min

	T(K)	[Tdiff]	Ns(nm-2)	Mu(cm2/Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.3	0.1	1.18	34.89	1510.31	0.662
blue	2.4	0.1	1.18	34.89	1510.25	0.662
green	4.5	0.12	1.21	34.3	1499.08	0.667
green	4.5	0.16	1.21	34.3	1499.03	0.667
red	8.9	0.26	1.24	33.69	1489.42	0.671
red	8.9	0.26	1.24	33.7	1489.41	0.671
cyan	11.5	0.58	1.25	33.47	1486.61	0.673
cyan	11.1	0.61	1.25	33.51	1486.89	0.673



Fig. 3c-d Nsi#129 850C 2min

	T(K)	[Tdiff]	Ns(nm⁻²)	Mu(cm²/Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.3	0.06	3.23	55.61	347.79	2.875
blue	2.3	0.06	3.24	55.46	347.78	2.875
green	4.4	0.05	3.25	55.28	347.42	2.878
green	4.5	0.29	3.3	54.38	347.4	2.879
red	8.8	0.23	3.31	54.31	347.27	2.88
red	8.7	0.28	3.26	55.13	347.25	2.88
cyan	11.3	0.98	3.3	54.36	347.41	2.878
cyan	10.8	0.51	3.27	55.02	347.34	2.879



Fig. 3c-d Nsi#129 in-situ

	T(K)	[Tdiff]	Ns(nm ⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.5	0.06	0.85	13.42	5500.54	0.182
blue	2.5	0.09	0.84	13.43	5502.46	0.182
green	4.4	0.89	0.9	12.88	5388.98	0.186
green	4.5	0.1	0.91	12.78	5387.05	0.186
red	8.9	0.23	0.98	12.13	5270.01	0.19



Fig. 3c-d Nsi#129 650C 2min

	T(K)	[Tdiff]	Ns(nm⁻²)	Mu(cm ² /Vs)	Rho0(Ohm)	Sig0(mS)
blue	2.4	0.08	1.11	33.05	1703.84	0.587
blue	2.3	0.06	1.11	33.03	1704.06	0.587
green	4.5	0.17	1.14	32.34	1692.09	0.591
green	4.5	0.22	1.14	32.35	1691.79	0.591
red	8.9	0.31	1.17	31.69	1682.47	0.594
red	8.7	0.42	1.17	31.71	1682.7	0.594



Fig. 4

raw STM images of device



A160620.102742.dat

A160620.102742.X.dat



A160620.145933.dat



A160620.145933.X.dat



at T > 40K substrate leakage dominates conductance

Fig. 4

D12_IV_NWGap(21-16)_04.5K001.dat D12_IV_NWGap(21-16)_10.0K005.dat D12_IV_NWGap(21-16)_04.5K002.dat D12_IV_NWGap(21-16)_20.0K001.dat D12_IV_NWGap(21-16)_06.0K002.dat D12_IV_NWGap(21-16)_30.0K001.dat D12_IV_NWGap(21-16)_10.0K001.dat D12_IV_NWGap(21-16)_30.0K002.dat D12_IV_NWGap(21-16)_10.0K002.dat D12_IV_NWGap(21-16)_40.0K001.dat D12_IV_NWGap(21-16)_10.0K003.dat D12_IV_NWGap(21-16)_50.0K001.dat D12_IV_NWGap(21-16)_10.0K004.dat D12_IV_NWGap(21-16)_50.0K002.dat D12_IV_NWGAP(21-16)_50.0K002.dat

slight non-linearity due to

Fig. 4 Determination of the activation energy for the gap section of the device

Fit Procedure for activation energy:

- fit polygon (polygon order n = 14 to 23) to region around $|V_{bias}| < co = 30, 32, 34, 36, 38, 40 \text{ mV}$
- analytically take derivative of polygon
- average conductance over region |V_{bias}| < 5mV
- fit average conductance values as a function of temperature
- vary n and co in the range specified above to check robustness of fit

The plot below shows the activation energy for the different parameter variations and yields the uncertainty of +/- 5meV stated in the paper for the activation energy.



raw SEM and STM images of device





sem_pn_device_overv.pdf



A160330.143938.dat



sem_pn_device_zoom.pdf



D02_IV_curve_10M_03-04_01.7K001.dat D02_IV_curve_10M_03-04_20.0K001.dat D02_IV_curve_10M_03-04_04.3K001.dat D02_IV_curve_10M_03-04_22.0K001.dat D02_IV_curve_10M_03-04_05.0K001.dat D02_IV_curve_10M_03-04_24.0K001.dat D02_IV_curve_10M_03-04_06.0K001.dat D02_IV_curve_10M_03-04_26.0K001.dat D02_IV_curve_10M_03-04_07.0K001.dat D02_IV_curve_10M_03-04_28.0K001.dat D02_IV_curve_10M_03-04_08.0K001.dat D02_IV_curve_10M_03-04_30.0K001.dat D02_IV_curve_10M_03-04_12.0K001.dat D02_IV_curve_10M_03-04_34.0K001.dat D02_IV_curve_10M_03-04_14.0K001.dat D02_IV_curve_10M_03-04_36.0K001.dat D02_IV_curve_10M_03-04_18.0K001.dat D02_IV_curve_10M_03-04_40.0K001.dat